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APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
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CONFIRMATION NO. 5083

FILING RECEIPT



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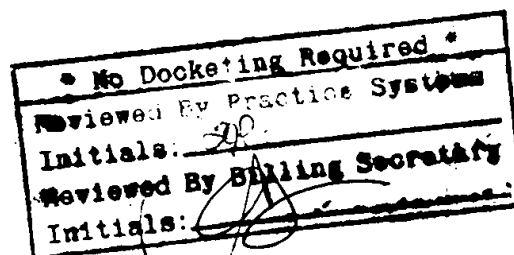
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Title

Semiconductor device and manufacturing method thereof